

2SJ217-VB Datasheet

P-Channel 60-V (D-S) MOSFET

PRODUCT SUMMARY					
V _{DS} (V)	R _{DS(on)} (Ω)	I _D (A) ^a	Q _g (Typ.)		
- 60	0.0160 at V _{GS} = - 10 V	- 53	38 nC		
- 80	0.0200 at V _{GS} = - 4.5 V	- 42	30 110		

FEATURES

- Trench Power MOSFET
- 100 % UIS Tested

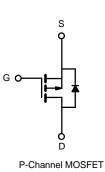
APPLICATIONS

· Load Switch





TO-3P



ABSOLUTE MAXIMUM RATINGS ($T_A = 25 \text{ °C}$, unless otherwise noted)								
Parameter	Symbol	Limit						
Drain-Source Voltage		V _{DS}	- 60					
Gate-Source Voltage		V _{GS}	± 25					
	T _C = 25 °C		- 53 ^a					
Continuous Drain Current ($T_1 = 150 \ ^{\circ}C$)	T _C = 70 °C		- 46.8					
Continuous Diain Current $(T_j = 150 \text{ C})$	T _A = 25 °C	I _D	-9.2 ^b					
	T _A = 70 °C		- 8.1 ^b					
Pulsed Drain Current	•	I _{DM}	- 200					

Parameter	Symbol	Limit	Unit		
Drain-Source Voltage	V _{DS}	- 60	V		
Gate-Source Voltage		V _{GS}	± 25	v	
Continuous Drain Current (T _J = 150 °C)	T _C = 25 °C		- 53 ^a		
	T _C = 70 °C		- 46.8		
	T _A = 25 °C	I _D	-9.2 ^b	A	
	T _A = 70 °C		- 8.1 ^b	A	
Pulsed Drain Current		I _{DM}	- 200	1	
Avalanche Current Pulse	L = 0.1 mH	I _{AS}	- 45		
Single Pulse Avalanche Energy	L = 0.1 mm	E _{AS}	101	mJ	
Continuous Source-Drain Diode Current	T _C = 25 °C	I _S	69 ^a	Α	
Continuous Source-Drain Diode Current	T _A = 25 °C	'S	2.1 ^b	A	
Maximum Power Dissipation	T _C = 25 °C		104.2 ^a		
	T _C = 70 °C		66.7 ^a		
	T _A = 25 °C	P _D	3.1 ^b	W	
	T _A = 70 °C		2 ^b		
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 150	°C	

THERMAL RESISTANCE RATINGS					
Parameter		Symbol	Typical	Maximum	Unit
Maximum Junction-to-Ambient ^b	Steady State	R _{thJA}	33	40	°C/W
Maximum Junction-to-Case	Steady State	R _{thJC}	0.98	1.2	0/10

Notes:

a. Based on T_C = 25 °C.

b. Surface mounted on 1" x 1" FR4 board.

SPECIFICATIONS (T _J = 25 $^{\circ}$ C,	unless othe	erwise noted)					
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static						•	
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 V, I_D = -250 \mu A$	- 60			V	
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	I _D = - 250 μΑ		68		mV/°C	
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	η = - 200 μΛ		- 5.2			
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = -250 \ \mu A$	- 1		- 3	V	
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 100	nA	
Zana Cata Maltana Duain Comant		$V_{DS} = -60 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$			- 1		
Zero Gate Voltage Drain Current	IDSS	V_{DS} = - 60 V, V_{GS} = 0 V, T_{J} = 55 °C			- 10	μΑ	
On-State Drain Current ^a	I _{D(on)}	V _{DS} = - 5 V, V _{GS} = - 10 V	- 120			Α	
Drain-Source On-State Resistance ^a	Р	V _{GS} = - 10 V, I _D = - 30 A		0.0160			
	R _{DS(on)}	V _{GS} = - 4.5 V, I _D = - 20 A		0.0200		Ω	
Forward Transconductance ^a	9 _{fs}	V _{DS} = - 15 V, I _D = - 50 A	20			S	
Dynamic ^b	•			•			
Input Capacitance	C _{iss}			3500		pF	
Output Capacitance	C _{oss}	V_{DS} = - 25 V, V_{GS} = 0 V, f = 1 MHz		390			
Reverse Transfer Capacitance	C _{rss}			290			
Total Cata Charge	Qg	$V_{DS} = -30$ V, $V_{GS} = -10$ V, $I_{D} = -55$ A		76	115		
Total Gate Charge				38	60	nC	
Gate-Source Charge	Q _{gs}	$V_{\rm DS}$ = - 30 V, $V_{\rm GS}$ = - 4.5 V, $I_{\rm D}$ = - 55 A		16		nC	
Gate-Drain Charge	Q _{gd}			19			
Gate Resistance	Rg	f = 1 MHz		5.2		Ω	
Turn-On Delay Time	t _{d(on)}			10	15		
Rise Time	t _r	V_{DD} = - 2 V, R_L = 2 Ω		7	15	- ns	
Turn-Off Delay Time	t _{d(off)}	$I_{D}\cong$ - 10 A, V_{GEN} = - 10 V, R_{g} = 1 Ω		70	110		
Fall Time	t _f			40	60		
Drain-Source Body Diode Characteristic	s						
Continuous Source-Drain Diode Current	۱ _S	T _C = 25 °C			- 69	٨	
Pulse Diode Forward Current ^a	I _{SM}				- 150	- A	
Body Diode Voltage	V _{SD}	I _S = - 30 A		- 1	- 1.5	V	
Body Diode Reverse Recovery Time	t _{rr}			45	68	ns	
Body Diode Reverse Recovery Charge	Q _{rr}	I _F = - 50 A, di/dt = 100 A/μs, T _{.I} = 25 °C		59	120	nC	
Reverse Recovery Fall Time	t _a	$T_{\rm F} = -50$ A, $u/ut = 100$ A/µs, $T_{\rm J} = 25$ °C		29		ns	
Reverse Recovery Rise Time	t _b			16			

Notes:

a. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %.

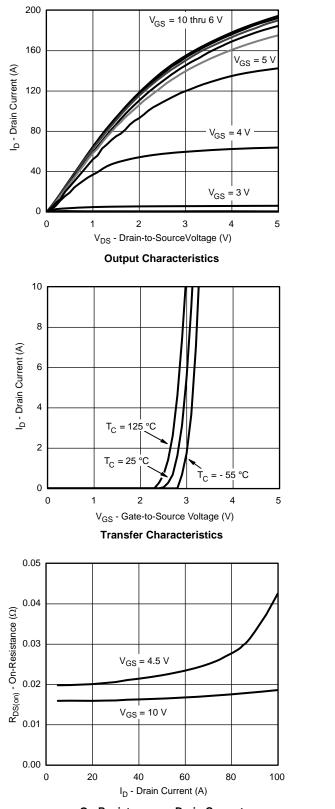
b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

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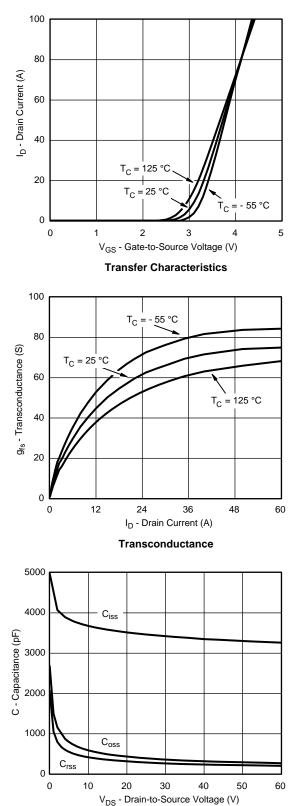
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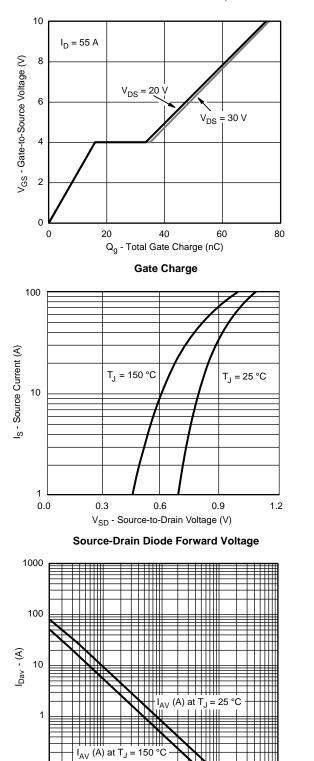
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

On-Resistance vs. Drain Current



Capacitance





TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

 $\label{eq:Tin-s} T_{\text{in}} \text{-} (s)$ Single Pulse Avalanche Current Capability vs. Time

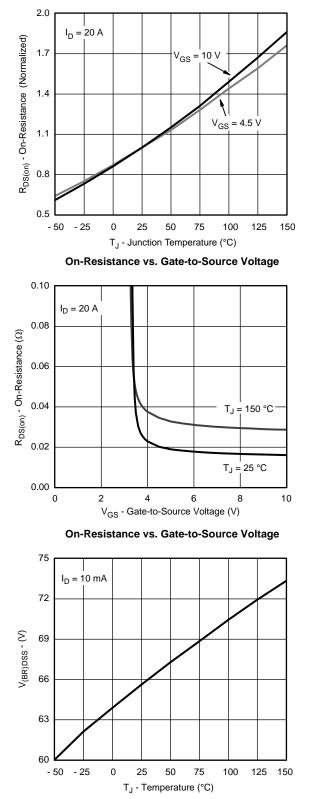
0.01

0.1

1

11111

0.001

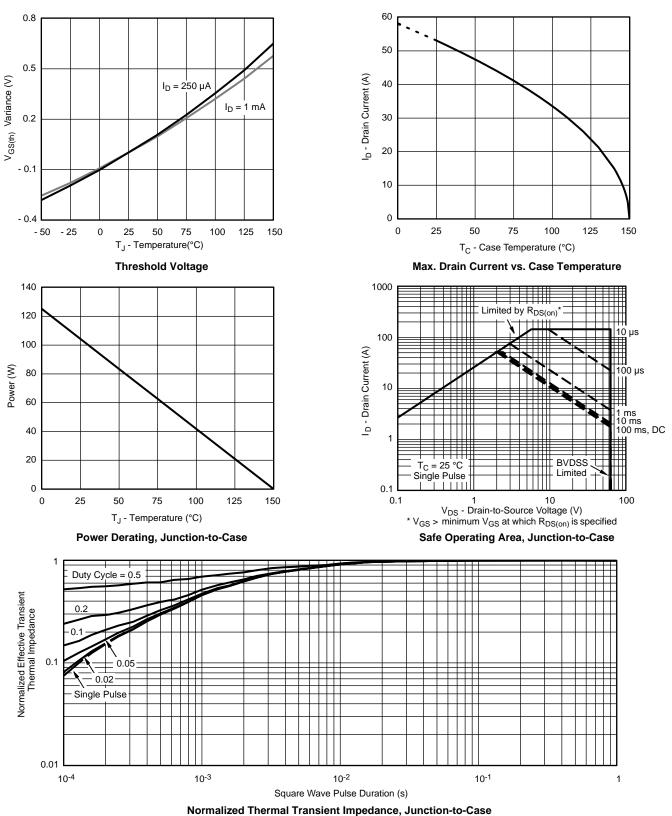


Drain-Source Breakdown Voltage vs. Junction Temperature

0.1

0.0001

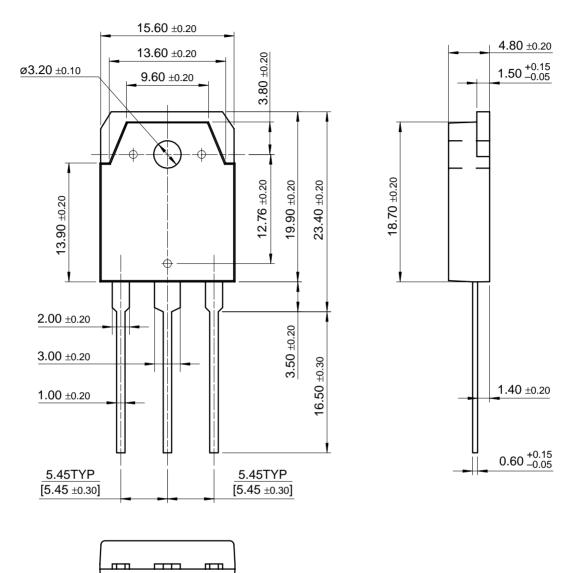




TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



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